Click here to ask about the production status of specific part numbers.

MAX22507E/MAX22508E

50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity

General Description

The MAX22507E/MAX22508E ESD-protected RS-485/ RS-422 full-duplex transceivers are optimized for highspeed communication up to 50Mbps. These transceivers feature integrated hot-swap protection and a fail-safe receiver, ensuring a logic-high on the receiver output when input signals are shorted or open for longer than 10µs (typ). Additionally, a large receiver hysteresis improves noise rejection and signal integrity.

The MAX22507E/MAX22508E are designed to operate in harsh industrial environments and are optimized for robust communication in environments with high levels of electromagnetic interference (EMI).

The MAX22507E is available in a 10-pin μ MAX package and the MAX22508E is available in an 8-pin SOIC package. μ MAX is the Maxim-trademarked equivalent to the industry-standard MSOP package. Both transceivers operate over the -40°C to +125°C temperature range.

Applications

- Motion Control
- Encoder Interfaces
- Field Bus Networks
- Industrial Control Systems
- Backplane Busses

Benefits and Features

- High-Speed Operation Over Long Distances
 - Up to 50Mbps Data Rate
 - High Receiver Sensitivity
 - Wide Receiver Bandwidth
 - Symmetrical Receiver Thresholds
- Integrated Protection Increases Robustness
 15/(to 115)/Common Mode Dange
 - -15V to +15V Common Mode Range
 - ±15kV ESD Protection (Human Body Model)
 - ±7kV IEC 61000-4-2 Air-Gap ESD Protection
 - ±6kV IEC 61000-4-2 Contact Discharge ESD Protection
 - Withstands Over ±4kV EFT
 - Driver Outputs are Short-Circuit Protected
- Flexibility for Many Different Applications
 - 3V to 5.5V Supply Range
 - Low 5µA (max) Shutdown Current (MAX22507E)
 - Allows up to 200 Transceivers on the Bus
 - Available in a 10-pin µMAX Package (MAX22507E) and 8-pin SOIC Package (MAX22508E)
 - -40°C to +125°C Operating Temperature Range

Ordering Information appears at end of data sheet.

Simplified Block Diagram



 μ MAX is a registered trademark of Maxim Integrated Products, Inc.



50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity

Absolute Maximum Ratings

V _{CC}	0.3V to +6V
RĚ, DE, DI	
RO0.3V to	$(V_{CC} + 0.3V)$
A, B, Y, Z	-15V to +15V
Short-Circuit Duration (RO, A, B, Y, Z) to GND	Continuous
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
10-Pin UMAX (derate 8.8m/M/°C above +70°C)	707 3m\//

10-Pin µMAX (derate 8.8mW/°C above +70°C)....... 707.3mW

8-Pin SOIC (derate 7.4mW/°C above +70°C)	588.2mW
Operating Temperature Range	40°C to +125°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering 10s)	+300°C
Reflow Temperature	+270°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

µMAX10

Package Code	U10+6C				
Outline Number	<u>21-0061</u>				
Land Pattern Number	<u>90-0330</u>				
THERMAL RESISTANCE, FOUR-LAYER BOARD					
Junction to Ambient (θ _{JA})	113.1°C/W				
Junction to Case (θ_{JC})	42°C/W				

SOIC8

Package Code	S8+2C				
Outline Number	<u>21-0041</u>				
Land Pattern Number	<u>90-0096</u>				
THERMAL RESISTANCE, FOUR-LAYER BOARD					
Junction to Ambient (0 _{JA})	136°C/W				
Junction to Case (θ_{JC})	38°C/W				

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/</u> <u>thermal-tutorial</u>.

Electrical Characteristics

 $(V_{CC} = 3V \text{ to } 5.5V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = 3.3V \text{ and } T_A = +25^{\circ}C.)$ (Notes 1, 2)

PARAMETER SYMBOL		CONDITIONS	MIN	TYP	MAX	UNITS		
DC ELECTRICAL CHARACTERISTICS / POWER								
Supply Voltage	V _{CC}		3.0		5.5	V		
Supply Current	Icc	DE = high, \overline{RE} = low, no load		4	5.6	mA		
Shutdown Supply Current ISHDN M/		MAX22507E only, DE = low, \overline{RE} = high			5	μA		

50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity

Electrical Characteristics (continued)

 $(V_{CC} = 3V \text{ to } 5.5V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = 3.3V \text{ and } T_A = +25^{\circ}C.)$ (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DC ELECTRICAL CHARA	ACTERISTICS	DRIVER					
Differential Driver	\/	Figure 1	R _L = 54Ω	1.5			v
Output	V _{OD}	Figure 1	R _L = 100Ω	2.0			
Change in Magnitude of Differential Output Voltage	ΔV _{OD}	R _L = 54Ω, <u>Figure 1</u> (Note 3)			0.2	v
Driver Common-Mode Output Voltage	V _{OC}	R _L = 54Ω, <u>Figure 1</u>			V _{CC} / 2	3	V
Change in Magnitude of Common-Mode Voltage	ΔV _{OC}	R _L = 100Ω or 54Ω, <u>F</u>	Figure 1 (Note 3)			0.2	V
Single-Ended Driver Output High	V _{OH}	Y or Z output, I _{OUT} :	= -20mA	2.2			V
Single-Ended Driver Output Low	V _{OL}	Y or Z output, I _{OUT} :	= +20mA			0.8	V
Differential Output Capacitance	C _{OD}	DE = high, f = 4MHz			50		pF
Driver Short-Circuit Output Current	I _{OST}	-15V ≤ V _{OUT} ≤ +15\	1			250	mA
DC ELECTRICAL CHARA	ACTERISTICS	RECEIVER					
nput Current (A and B)	I _{A,B}	$V_{CC} = 0V \text{ or}$ $3V \le V_{CC} \le 5.5V$	V _{IN} = +12V V _{IN} = -7V	-106		+160	μA
Differential Input Capacitance	C _{A,B}	Between A and B, f	Between A and B, f = 2MHz		50		pF
Common-Mode Voltage Range	V _{CM}					+15	V
Receiver Differential- Threshold High	V _{TH_H}	-15V ≤ V _{CM} ≤ +15V		+50	+122	+200	mV
Receiver Differential- Threshold Low	V _{TH_L}	$-15 \text{V} \leq \text{V}_{\text{CM}} \leq +15 \text{V}$		-200	-122	-50	mV
Receiver Input Hysteresis	ΔV_{TH}	V_{CM} = 0V, time from is < t_{D_FS}	last transition		250		mV
Differential Input Fail-Safe Level	V _{TH_FS}	$-15V \le V_{CM} \le +15V$, transition > t _{F_DS}	time from last	-50		+50	mV
DC ELECTRICAL CHARA	ACTERISTICS	LOGIC INTERFACE (RE, RO, DE, DI)				
Input-Voltage High	V _{IH}	DE, DI, RE	$3V \le V_{CC} \le 5.5V$	2/3 x V _{CC}			v
			V _{CC} = 5.25V	2.85			
Input-Voltage Low	V _{IL}	DE, DI, RE				1/3 x V _{CC}	V
Input Current	I _{IN}	DE, DI, RE (after firs	DE, DI, RE (after first transition)			+2	μA
Input Impedance on First Transition	R _{IN_FT}	MAX22507E only, D	E, RE			10	kΩ
RO Output-High Voltage	V _{OH}	$\overline{\text{RE}}$ = low, (V _A - V _B) I _{OUT} = -5mA	> 200mV,	V _{CC} – 0.4			V

50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity

Electrical Characteristics (continued)

(V_{CC} = 3V to 5.5V, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at V_{CC} = 3.3V and $T_A = +25^{\circ}$ C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
RO Output-Low Voltage	V _{OL}	$\overline{\text{RE}}$ = low, (V _A -V _B) < -200mV, I _{OUT} = +5mA			0.4	V
Three-State Output Current at Receiver	I _{OZR}	$\begin{array}{l} \text{MAX22507E only, } \overline{\text{RE}} = \text{high, } 0 \leq V_{\text{RO}} \leq \\ V_{\text{CC}} \end{array}$	≤ -1 +1		+1	μA
PROTECTION						
Thermal-Shutdown Threshold	+1bl)			°C		
Thermal-Shutdown Hysteresis	T _{SH_HYS}			10		°C
		Human Body Model		±15		
ESD Protection (A, B, Y, and Z Pins)		IEC61000-4-2 Air Gap Discharge to GND		±7		kV
(,, ,, ,, ,, ,, ,, ,, ,, ,, ,, ,, ,, ,,		IEC61000-4-2 Contact Discharge to GND		±6		
ESD Protection (All Other Pins)		Human Body Model		±2		kV
AC ELECTRICAL CHARA	ACTERISTICS /	DRIVER (Note 4)				
Driver Propagation	t _{DPLH}	$R_L = 54\Omega$, $C_L = 50pF$, Figure 2, Figure 3			32	
Delay	t _{DPHL}	$R_L = 54\Omega$, $C_L = 50pF$, Figure 2, Figure 3			32	- ns
Differential-Driver Output Skew	t _{DSKEW}	$ t_{DPI H} - t_{DPHI} $, R _I = 540, C _I = 50pF.		1.2	ns	
Driver Differential- Output Rise and Fall Time			3	ns		
Maximum Data Rate	DR		50			Mbps
Driver Enable to Output High	t _{DZH}	MAX22507E only, $R_L = 500\Omega$, $C_L = 50pF$, Figure 4			32	ns
Driver Enable to Output Low	t _{DZL}	MAX22507E only, R_L = 500 Ω , C_L = 50pF, Figure 5			32	ns
Driver Disable Time from High	^t DHZ	MAX22507E only, R_L = 500 Ω , C_L = 50pF, Figure 4			32	ns
Driver Disable Time from Low	t _{DLZ}	MAX22507E only, R_L = 500 Ω , C_L = 50pF, Figure 5			32	ns
Driver Enable from Shutdown to Output t _{DZH(SHDN)} High		MAX22507E only, R _L = 1k Ω , C _L = 15pF, Figure 4			100	μs
Driver Enable from Shutdown to Output Low	t _{DZL} (SHDN)	MAX22507E only, R _L = 1k Ω , C _L = 15pF, Figure 5			100	μs
Time to Shutdown	t _{SHDN}	MAX22507E only, (Notes 6, 7)	50		800	ns
AC ELECTRICAL CHARA	ACTERISTICS /	RECEIVER (Note 4)				
Delay to Fail-Safe Operation	^t D_FS	10			μs	
Receiver Propagation Delay	t _{RPLH} , t _{RPHL}	C _L = 15pF, <i><u>Figures 6</u>, <u>7</u> 40</i>		40	ns	
Receiver Output Skew	It points a topical $C_1 = 15$ pE Figures 6.7		2.5	ns		

50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity

Electrical Characteristics (continued)

(V_{CC} = 3V to 5.5V, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at V_{CC} = 3.3V and $T_A = +25^{\circ}$ C.) (Notes 1, 2)

		51	50	<i>/</i> \	, (. ,
PARAMETER SYMBOL		CONDITIONS	MIN	ТҮР	MAX	UNITS
Maximum Data Rate	DR		50			Mbps
Receiver Enable to Output High	^t RZH	MAX22507E only, $R_L = 1k\Omega$, $C_L = 15pF$, Figure 8			32	ns
Receiver Enable to Output Low	t _{RZL}	MAX22507E only, $R_L = 1k\Omega$, $C_L = 15pF$, Figure 8			32	ns
Receiver Disable Time from Low t _{RLZ}		MAX22507E only, $R_L = 1k\Omega$, $C_L = 15pF$, Figure 8			32	ns
Receiver Disable Time from High		MAX22507E only, $R_L = 1k\Omega$, $C_L = 15pF$, Figure 8			32	ns
Receiver Enable from Shutdown to Output t _{RZH(SHDN)} High		MAX22507E only, $R_L = 1k\Omega$, $C_L = 15pF$, Figure 8			100	μs
Receiver Enable from Shutdown to Output Low ^t RZL(SHDN)		MAX22507E only, $R_L = 1k\Omega$, $C_L = 15pF$, Figure 8			100	μs
Time to Shutdown	^t SHDN	MAX22507E only, (Notes 6, 7)	50		800	ns

Note 1: All devices are 100% production tested at T_A = +25°C. Specifications for all temperature limits are guaranteed by design.

Note 2: All currents into the device are positive. All currents out of the device are negative. All voltages are referenced to the device ground, unless otherwise noted.

Note 3: ΔV_{OD} and ΔV_{OC} are the changes in V_{OD} and V_{OC} , respectively, when the DI input changes state.

Note 4: Capacitive load includes test probe and fixture capacitance.

Note 5: Not production tested. Guaranteed by design.

Note 6: Shutdown is enabled by driving RE high and DE low. The device is guaranteed to have entered shutdown after t_{SHDN} has elapsed.

Note 7: Time to shutdown refers to the driver or receiver enable delay when the device has exited the initial hot-swap protect state and is in normal operating mode.



Figure 1. Driver DC Test Load



Figure 2. Driver Timing Test Circuit







Figure 4. Driver Enable and Disable Times (t_{DZH}, t_{DHZ})



Figure 5. Driver Enable and Disable Times (t_{DZL}, t_{DLZ})



Figure 6. Receiver Propagation Delay Test Circuit



Figure 7. Receiver Propagation Delays



Figure 8. Receiver Enable and Disable Times

50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity

Typical Operating Characteristics

 $(V_{CC} = 5V, 60\Omega \text{ termination between the driver outputs}, T_A = 25^{\circ}C, \text{ unless otherwise noted.})$



50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity

Typical Operating Characteristics (continued)

 $(V_{CC} = 5V, 60\Omega \text{ termination between the driver outputs}, T_A = 25^{\circ}C, \text{ unless otherwise noted.})$









50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity

Pin Configurations

MAX22507E



MAX22508E



Pin Description

P	PIN		FUNCTION	
MAX22507E	MAX22508E	NAME	FUNCTION	
1	2	RO	Receiver Output. See the <u>MAX22507E and MAX22508E Receiving Tables</u> for more information.	
2	_	RE	Receiver Enable. Pull \overline{RE} high to disable the receiver and three-state RO. The device is in low-power shutdown when \overline{RE} = high and DE = low.	
3	_	DE	\overline{E} Driver Output Enable. Force DE high to enable the driver. The device is in low-power shutdown when \overline{RE} = high and DE = low.	
4	3	DI	Driver Input. See the <u>MAX22507E and MAX22708E Transmitting Tables</u> for more information.	
5	4	GND	Ground	
6	5	Y	Noninverting Driver Output	
7	6	Z	Inverting Driver Output	
9	7	А	Noninverting Receiver Input	
8	8	В	Inverting Receiver Input	
10	1	V _{CC}	Supply Input. Bypass V_{CC} to ground with a 0.1µF ceramic capacitor as close to the device as possible.	

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Function Tables

MAX22507E Transmitting Table

INPUTS			OUTPUTS				
RE	DE	DI	Y	Z			
Х	1	1	1	0			
Х	1	0	0	1			
0	0	Х	High Impedance High Impedance				
1	0	Х	Shutdown—Driver outputs are high impedance				

X = Don't care

MAX22508E Transmitting Table

INPUTS	OUTPUTS			
DI	Y Z			
1	1	0		
0	0	1		

MAX22507E Receiving Table

		INPUTS	OUTPUTS	
RE	DE	(V _A - V _B)	Time from Last A-B Transition	RO
0	Х	≥ +200mV	Always	1
0	x	-200mV < (V _A - V _B) < +200mV	< t _{D_FS}	Indeterminate— RO is latched to previous value
0	Х	-50mV < (V _A - V _B) < +50mV	> t _{D_FS}	1
0	Х	≤ -200mV	Always	0
0	Х	Open/Shorted	> t _{D_FS}	1
1	1	X	X	High Impedance
1	0	Х	Х	Shutdown—RO is high impedance

X = Don't care

MAX22508E Receiving Table

INPUTS		OUTPUTS	
(V _A - V _B)	Time from Last A-B Transition	RO	
≥ +200mV	Always	1	
-200mV < (V _A - V _B) < +200mV	< t _{D_FS}	Indeterminate— RO is latched to previous value	
-50mV < (V _A - V _B) < +50mV	> t _{D_FS}	1	
≤ -200mV	Always	0	
Open/Shorted	> t _{D_FS}	1	

50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity

Detailed Description

The MAX22507E/MAX22508E ESD-protected RS-485/RS-422 transceivers are optimized for high-speed communications up to 50Mbps. These transceivers feature integrated hot-swap functionality to eliminate false transitions on the driver during power-up or during a hot-plug event. These transceivers also feature fail-safe receiver inputs, guaranteeing a logic-high on the receiver output when inputs are shorted or open for longer than 10µs (typ).

Receiver Threshold Voltages

The device receiver features a large threshold hysteresis of 250mV (typ) for increased differential noise rejection. Additionally, the receiver features symmetrical threshold voltages. Symmetric thresholds have the advantage that recovered data at the RO output does not have duty-cycle distortion. Typically, fail-safe receivers, which have unipolar (non-symmetric) thresholds, show some duty-cycle distortion at high signal attenuation due to long cable lengths.

Fail-Safe Functionality

The MAX22507E/MAX22508E feature fail-safe receiver inputs, guaranteeing a logic-high on the receiver output (RO) when the receiver inputs are shorted or open for longer than 10µs (typ). When the differential receiver input voltage is between ± 50 mV, or -50mV \leq (V_A - V_B) \leq +50mV, for more than 10µs (typ), RO is logic-high. For example, in the case of a terminated bus with all transmitters disabled, the receiver differential input voltage is pulled to 0V by the termination resistor, so -50mV \leq (V_A - V_B) = 0V \leq +50mV and RO is guaranteed to be a logic high after 10µs (typ).

Driver Single-Ended Operation

The driver outputs of the MAX22507E/MAX22508E can be used in the standard differential operating mode or as singleended outputs. Because the driver outputs swing rail-to-rail, they can also be used as individual standard TTL or CMOS logic outputs.

Hot-Swap Capability

The DE and $\overline{\text{RE}}$ enable inputs feature hot-swap functionality. At each input there are two nMOS devices, M1 and M2 (Figure 9). When V_{CC} ramps from zero, an internal 10µs timer turns on M2 and sets the SR latch, which also turns on M1. Transistors M2 (a 500µA current sink) and M1 (a 100µA current sink) pull DE to GND through a 5k Ω resistor. M2 is designed to pull DE to the disabled state against an external parasitic capacitance up to 100pF that can drive DE high. After 10µs, the timer deactivates M2 while M1 remains on, holding DE low against three-state leakages that can drive DE high. M1 remains on until an external source overcomes the required input current. At this time, the SR latch resets and M1 turns off. When M1 turns off, DE reverts to a standard, high-impedance CMOS input. Whenever V_{CC} drops below 1V, the hot-swap input is reset.

Note: Figure 9 shows a complementary circuit for \overline{RE} that uses two pMOS devices to pull \overline{RE} to V_{CC}.

50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity



Figure 9. Simplified Structure of the Driver Enabled (DE) Pin

Driver Output Protection

Two mechanisms prevent excessive output current and power dissipation caused by faults or by bus contention. The first, a current limit on the output stage, provides immediate protection against short-circuits over the whole common-mode voltage range. The second, a thermal-shutdown circuit, forces the driver outputs into a high-impedance state if the die temperature exceeds +160°C (typ).

Low-Power Shutdown Mode (MAX22507E Only)

The MAX22507E features a low-power shutdown mode to reduce supply current when the transceiver is not needed. Pull the \overline{RE} input high and the DE input low to put the device in low-power shutdown mode. If the inputs are in this state for at least 800ns, the parts are guaranteed to enter shutdown. The MAX22507E draws 5µA (max) of supply current when the device is in shutdown.

The $\overline{\text{RE}}$ and DE inputs can be driven simultaneously. The MAX22507E is guaranteed not to enter shutdown if $\overline{\text{RE}}$ is high and DE is low for less than 50ns.

Integrated ESD Protection

ESD protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The driver outputs and receiver inputs of the MAX22507E/MAX22508E have extra protection against static electricity. The ESD structures withstand high ESD in all states: normal operation, shutdown, and powered down. After an ESD event, the MAX22507E/MAX22508E are able to keep working without latch-up or damage.

ESD protection can be tested in various ways. The transmitter outputs and receiver inputs of the MAX22507E/ MAX22508E are characterized for protection to the following limits:

- ±15kV HBM
- ±7kV using the Air-Gap Discharge method specified in IEC 61000-4-2
- ±6kV using the Contact Discharge method specified in IEC 61000-4-2

Human Body Model (HBM)

<u>Figure 10</u> shows the HBM test model, and <u>Figure 11</u> shows the current waveform it generates when discharged into a low-impedance state. This models consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into a test device through a $1.5k\Omega$ resistor.

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Figure 10. Human Body ESD Test Model



Figure 11. Human Body Current Waveform

IEC 61000-4-2

The IEC 61000-4-2 standard covers ESD testing and performance of finished equipment. However, it does not specifically refer to integrated circuits. The integrated ESD protection circuitry in the transceiver helps in designing equipment to meet IEC 61000-4-2.

The major difference between tests done using the HBM and IEC 61000-4-2 models is the higher peak current in IEC 61000-4-2. This is due to the lower series resistance in the IEC 61000-4-2 model and typically results in the withstand voltage measured to IEC 61000-4-2 being generally lower than that measured using the HBM.

Figure 12 shows the IEC 61000-4-2 model and Figure 13 shows the current waveform for the IEC 61000-4-2 ESD Contact Discharge test.



Figure 12. IEC 61000-4-2 ESD Test Model



Figure 13. IEC 61000-4-2 ESD Generator Current Waveform

Applications Information

Transceivers on the Bus

The A and B receiver inputs have an input current of $160\mu A$ (max) at 12V and $-106\mu A$ (min) at -7V, respectively. According to the RS-485 standard, the relative receiver input resistance is calculated as $160\mu A/1mA = 0.16$ unit load (UL). Based on transmission lines terminated at two ends, up to 200 (= 32UL/0.16UL) MAX22507E/MAX22508E transceivers can be used on a multi-drop network. Note that this maximum number is calculated based on DC criteria only and does not take into consideration signal integrity and transmission line effects at high data rates.

Transient Protection

Transient events that can occur in industrial environments include electrostatic discharge (ESD), surge events (e.g., lightning strikes), and electrical fast transient (EFT) or burst events. Surge pulses typically have a longer duration and higher power-withstand requirements than EFT and ESD strikes. Test requirements and limits for ESD, surge, and burst conditions are included in the IEC 61000-4-2, IEC 61000-4-4, and IEC 6100-4-5 standards.

External ESD Protection

The MAX22507E/MAX22508E are internally protected against electrostatic discharge (ESD) events for the levels shown in the Protection section of the <u>Electrical Characteristics</u> table. While this internal protection increases the robustness of the device, additional external protection might be required to meet higher ESD limits or to protect against other high-voltage transients in the final application.

Electrical Fast Transient (EFT) Events

The IEC 61000-4-4 standard outlines the voltage levels and duration of an electrical fast transient (EFT) or burst event. EFT is typically a high-frequency, high-voltage burst that is coupled on to the RS-485 cable from external high-voltage switching signals. For example, switching from nearby relays or motors can generate EFT on a RS-485 data line. Relative to surge transient events, EFT bursts generate a small amount of power, but can corrupt data along the line.

To minimize the impact of EFT on signal lines, always use bypass capacitors soldered as close to the IC as possible. Additionally, common-mode chokes and TVS diodes can help to clamp high-voltage transients. Capacitive or resistorcapacitor filters can also be added on the signal lines. Shielded cables, if available, also help to reduce interference from EFT.

Surge Protection

Surge transient events can occur during lightning strikes, for example, and are characterized by the IEC 61000-4-5 standard. Surge events generate high energy with high voltage peaks and large currents being driven to the driver outputs and receiver inputs

Per the IEC 61000-4-5 standard, surge pulses must be referenced to protective earth (PE). Isolate PE from the field ground and connect a high voltage capacitor and a high voltage resistor between the field ground and PE. Figure 14 shows the current flow through the transceiver and PCB during a surge event. The MAX22507E/MAX22508E survived 8/ 20 μ s surge testing up to ±2kV/42 Ω with a 1000pF high-voltage capacitor without the need for external TVS protection.

50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity



Figure 14. Surge Protection

Layout Guidelines

The MAX22507E/MAX22508E are designed for robust communication in harsh industrial environments. Use the following guidelines for layout to ensure optimum performance:

- Place the bypass capacitor as close to the $V_{\mbox{CC}}$ pin as possible
- Use supply and ground planes to reduce trace inductance.
- Place external protection (resistors, capacitors, diodes) as close to the device as possible.
- Design protection components directly in the path of the driver output and receiver input signals.

Additionally, pull ground planes away from the RS-485/RS-422 data lines when operating at high data rates to reduce capacitive coupling that can slow edge rates.

50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity

Typical Application Circuits

Full Duplex Point-to-Point Network



Ordering Information

PART	DRIVER ENABLE	RECEIVER ENABLE	LOW-POWER SHUTDOWN	TEMP RANGE	PIN- PACKAGE	PACKAGE CODE
MAX22507EAUB+	Y	Y	Y	-40°C to +125°C	10 µMAX*	U10+6C
MAX22507EAUB+T	Y	Y	Y	-40°C to +125°C	10 µMAX*	U10+6C
MAX22508EASA+	Ν	Ν	Ν	-40°C to +125°C	8 SOIC	S8+2C
MAX22508EASA+T	Ν	Ν	Ν	-40°C to +125°C	8 SOIC	S8+2C

+ Denotes lead (Pb)-free/RoHS compliance.

T = Tape and reel.

* µMAX is the Maxim-trademarked equivalent to the industry-standard MSOP package.

50Mbps Full-Duplex RS-485/RS-422 Transceivers with High EFT Immunity

Revision History

REVISION	REVISION	DESCRIPTION	PAGES
NUMBER	DATE		CHANGED
0	5/21	Release for Market Intro	—

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